# 5145323-1 ACTIVE

#### **Smart Card**

TE Internal #: 5145323-1

Contact Module, 8 Position, 2.54 mm [.1 in] Centerline, Board Mount, -40 – 90 °C [-40 – 194 °F], Smart Card Connectors

View on TE.com >



Connectors > PCB Connectors > Memory Card Connectors > Smart Card Connectors



Smart Card Connector Product Type: Contact Module

Number of Positions: 8

Pre-Installed Wire & Cable: Without
Centerline (Pitch): 2.54 mm [.1 in]
Contact Current Rating (Max): .2 A

#### **Features**

#### **Product Type Features**

Connector & Contact Terminates To	Printed Circuit Board
Compatible Card	Smart Card
Smart Card Connector Product Type	Contact Module

#### **Configuration Features**

Card Detection Switch	With
Operating Function	NO
Cover	With
Number of Signal Positions	8
Number of Positions	8
Pre-Installed Wire & Cable	Without

## **Body Features**

Primary Product Color	Black	

## **Contact Features**

Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Current Rating (Max)	.2 A



#### **Termination Features**

Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Accepts Card Thickness	.76 mm[.03 in]
Profile Height from PCB	1.5 mm, 1.55 mm[.059 in]
Usage Conditions	
Operating Temperature Range	-40 – 90 °C[-40 – 194 °F]
Operation/Application	
Durability Rating	50000 Cycles
Circuit Application	Signal
Packaging Features	
Packaging Method	Carton
Packaging Quantity	750

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C



#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Customers Also Bought**









TE Part #W330TF11-23PN-151
SQ FLNG REC ASSEMBLY NO REAR
ACCESSORY W

#### **Documents**

**Product Drawings** 

**SMT CARD CONN LOW PROFILE 8POS** 

English

**CAD Files** 

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_5145323-1\_O.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5145323-1\_O.3d\_igs.zip

English



Customer View Model

ENG\_CVM\_CVM\_5145323-1\_O.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English